

## Board Stack Report

Stack Up		Layer Stack							
Layer	Board Layer Stack	Name	Material	Thickness	Constant	Dk	Coverlay expansion	Orientation	Copper Orientation
1	Height : 1.59144mm	Top Overlay		0mm					
2		Top Solder	Solder Resist	0.01016mm	3.5	3.5	0mm		
3		Top Layer		0.03556mm				BodyUp	Above
4		Dielectric 1	FR-4	1.5mm	4.8	4.8			
5		Bottom Layer		0.03556mm				BodyDown	Below
6		Bottom Solder	Solder Resist	0.01016mm	3.5	3.5	0mm		
7		Bottom Overlay		0mm					
	Height : 1.59144mm								